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Details

Product Status	Active
Core Processor	ARM® Cortex®-M23
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	25
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.62V ~ 3.63V
Data Converters	A/D 10x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	32-VFQFN Exposed Pad
Supplier Device Package	32-VQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsaml11e14a-mft

SAM L10/L11 Family

Peripherals Configuration Summary

Peripheral name	Base address	IRQ line	AHB clock		APB clock		Generic Clock	PAC		Events			DMA	Power domain
			Index	Enabled at Reset	Index	Enabled at Reset		Index	Write Protection at Reset	User	Generator	Sleep Walking	Index	
AHB-APB Bridge B	0x41000000	—	1	Y	—	—	—	—	—	—	—	N/A	—	PDSW
DSU	0x41002000	—	4	Y	1	Y	—	1	Y	—	—	N/A	2-3: DCC0-1	PDSW
NVMCTRL	0x41004000	9: DONE, PROGE, LOCKE, NVME, KEYE, NSCHK	7	Y	2	Y	—	2	N	2: AUTOW	—	Y	—	PDSW
DMAC	0x41006000	11: SUSP0, TERR0, TCMPLO 12: SUSP1, TERR1, TCMPLO 13: SUSP2, TERR2, TCMPLO 14: SUSP3, TERR3, TCMPLO 15: SUSP4-7, TERR4-7, TCMPLO4-7	3	Y	—	—	—	3	—	7-10: CH0-3	25-28: CH0-3	Y	—	PDSW
HMATRIXHS	0x41008000	—	5	Y	—	—	—	4	N	—	—	N/A	—	PDSW
AHB-APB Bridge C	0x42000000	—	2	Y	—	—	—	—	—	—	—	N/A	—	PDSW
EVSYS	0x42000000	16: EVD0, OVR0 17: EVD1, OVR1 18: EVD2, OVR2 19: EVD3, OVR3 20: NSCHK	—	—	0	Y	6: CH0 7: CH1 8: CH2 9: CH3	0	N	—	—	N/A	—	PDSW
SERCOM0	0x42000400	22: bit 0 23: bit 1 24: bit 2 25: bit 3-6	—	—	1	Y	11: CORE 10: SLOW	1	N	—	—	N/A	4: RX 5: TX	PDSW
SERCOM1	0x42000800	26: bit 0 27: bit 1 28: bit 2 29: bit 3-6	—	—	2	Y	12: CORE 10: SLOW	2	N	—	—	N/A	6: RX 7: TX	PDSW
SERCOM2	0x42000C00	30: bit 0 31: bit 1 32: bit 2 33: bit 3-6	—	—	3	Y	13: CORE 10: SLOW	3	N	—	—	N/A	8: RX 9: TX	PDSW
TC0	0x42001000	34: ERR, MC0, MC1, OVF	—	—	4	Y	14	4	N	11: EVU	29: OVF 30-31: MC0-1	Y	10: OVF 11-12: MC0-1	PDSW
TC1	0x42001400	35: ERR, MC0, MC1, OVF	—	—	5	Y	14	5	N	12: EVU	32: OVF 33-34: MC0-1	Y	13: OVF 14-15: MC0-1	PDSW
TC2	0x42001800	36: ERR, MC0, MC1, OVF	—	—	6	Y	15	6	N	13: EVU	35: OVF 36-37: MC0-1	Y	16: OVF 17-18: MC0-1	PDSW
ADC	0x42001C00	37: OVERRUN, WINMON 38: RESRDY 39: WINMON	—	—	7	Y	16	7	N	14: START 15: SYNC	38: RESRDY 39: WINMON	Y	19: RESRDY	PDSW
DAC	0x42002000	40: UNDERRU	—	—	8	Y	18	8	N	18: START	43: EMPTY	Y	20: EMPTY	PDSW

15.7.12 Peripheral Non-Secure Status - Bridge A

Name: NONSECA
Offset: 0x54
Reset: x initially determined from NVM User Row after reset
Property: Write-Secure



Important: This register is only available for **SAM L11** and has no effect for **SAM L10**.

Reading NONSEC register returns peripheral security attribution status:

Value	Description
0	Peripheral is secured.
1	Peripheral is non-secured.

Bit	31	30	29	28	27	26	25	24
Access								
Reset								
Bit	23	22	21	20	19	18	17	16
Access								
Reset								
Bit	15	14	13	12	11	10	9	8
			AC	PORT	FREQM	EIC	RTC	WDT
Access			R/R/R	R/R/R	R/R/R	R/R/R	R/R/R	R/R/R
Reset			x	x	x	x	x	x
Bit	7	6	5	4	3	2	1	0
	GCLK	SUPC	OSC32KCTRL	OSCCTRL	RSTC	MCLK	PM	PAC
Access	R/R/R	R/R/R	R/R/R	R/R/R	R/R/R	R/R/R	R/R/R	R/R/R
Reset	x	x	x	x	x	x	x	0

Bit 13 – AC Peripheral AC Non-Secure

Bit 12 – PORT Peripheral PORT Non-Secure

Bit 11 – FREQM Peripheral FREQM Non-Secure

Bit 10 – EIC Peripheral EIC Non-Secure

Bit 9 – RTC Peripheral RTC Non-Secure

Offset	Name	Bit Pos.								
0x1FF4	CID1	7:0	CCLASS[3:0]				PREAMBLE[3:0]			
		15:8								
		23:16								
		31:24								
0x1FF8	CID2	7:0	PREAMBLEB2[7:0]							
		15:8								
		23:16								
		31:24								
0x1FFC	CID3	7:0	PREAMBLEB3[7:0]							
		15:8								
		23:16								
		31:24								

16.12 Register Description

Registers can be 8, 16, or 32 bits wide. Atomic 8-, 16- and 32-bit accesses are supported. In addition, the 8-bit quarters and 16-bit halves of a 32-bit register, and the 8-bit halves of a 16-bit register can be accessed directly.

Some registers are optionally write-protected by the Peripheral Access Controller (PAC). Optional PAC write-protection is denoted by the "PAC Write-Protection" property in each individual register description. For details, refer to [16.5.7 Register Access Protection](#).

On **SAM L11** devices, this peripheral has different access permissions depending on PAC Security Attribution (Secure or Non-Secure):

- If the peripheral is configured as Non-Secure in the PAC:
 - Secure access and Non-Secure access are granted
- If the peripheral is configured as Secure in the PAC:
 - Secure access is granted
 - Non-Secure access is discarded (Write is ignored, read 0x0) and a PAC error is triggered

Refer to *Peripherals Security Attribution* for more information.

16.12.3 Status B

Name: STATUSB
Offset: 0x0002
Reset: 0xX
Property: PAC Write-Protection

Bit	7	6	5	4	3	2	1	0
	BCCDx	BCCDx	DCCDx	DCCDx	HPE	DBGPRES	DAL[1:0]	
Access	R	R	R	R	R	R	R	R
Reset	0	0	0	0	1	0	0	x

Bits 7,6 – BCCDx BOOT Communication Channel x Dirty [x=1..0]

Writing a '0' to this bit has no effect.

Writing a '1' to this bit has no effect.

This bit is set when BCCx is written.

This bit is cleared when BCCx is read.

Bits 5,4 – DCCDx Debug Communication Channel x Dirty [x=1..0]

Writing a '0' to this bit has no effect.

Writing a '1' to this bit has no effect.

This bit is set when DCCx is written.

This bit is cleared when DCCx is read.

Bit 3 – HPE Hot-Plugging Enable

Writing a '0' to this bit has no effect.

Writing a '1' to this bit has no effect.

This bit is set when Hot-Plugging is enabled.

This bit is cleared when Hot-Plugging is disabled. This is the case when the SWCLK function is changed. Only a power-reset or a external reset can set it again.

Bit 2 – DBGPRES Debugger Present

Writing a '0' to this bit has no effect.

Writing a '1' to this bit has no effect.

This bit is set when a debugger probe is detected.

This bit is never cleared.

Bits 1:0 – DAL[1:0] Debugger Access Level

Indicates the debugger access level:

- 0x0: Debugger can only access the DSU external address space.
- 0x1: Debugger can access only Non-Secure regions (SAM L11 only).
- 0x2: Debugger can access secure and Non-Secure regions.

21.8.1 Reset Cause

Name: RCAUSE
Offset: 0x00
Property: –

When a Reset occurs, the bit corresponding to the Reset source is set to '1' and all other bits are written to '0'.

Bit	7	6	5	4	3	2	1	0
		SYST	WDT	EXT		BOD33	BOD12	POR
Access		R	R	R		R	R	R
Reset		x	x	x		x	x	x

Bit 6 – SYST System Reset Request

This bit is set if a System Reset Request has occurred. Refer to the Cortex processor documentation for more details.

Bit 5 – WDT Watchdog Reset

This bit is set if a Watchdog Timer Reset has occurred.

Bit 4 – EXT External Reset

This bit is set if an external Reset has occurred.

Bit 2 – BOD33 Brown Out 33 Detector Reset

This bit is set if a BOD33 Reset has occurred.

Bit 1 – BOD12 Brown Out 12 Detector Reset

This bit is set if a BOD12 Reset has occurred.

Bit 0 – POR Power On Reset

This bit is set if a POR has occurred.

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OSCCTRL – Oscillators Controller

STARTUP[3:0]	Number of OSCULP32K Clock Cycles	Number of XOSC Clock Cycles	Approximate Equivalent Time [μ s]
0xE	16384	3	500000
0xF	32768	3	1000000

Note:

1. Actual startup time is 1 OSCULP32K cycle + 3 XOSC cycles.
2. The given time neglects the three XOSC cycles before OSCULP32K cycle.

Bit 11 – AMPGC Automatic Amplitude Gain Control

Note: This bit must be set only after the XOSC has settled, indicated by the XOSC Ready flag in the Status register (STATUS.XOSCRDY).

Value	Description
0	The automatic amplitude gain control is disabled.
1	The automatic amplitude gain control is enabled. Amplitude gain will be automatically adjusted during Crystal Oscillator operation.

Bits 10:8 – GAIN[2:0] Oscillator Gain

These bits select the gain for the oscillator. The listed maximum frequencies are recommendations, and might vary based on capacitive load and crystal characteristics. Those bits must be properly configured even when the Automatic Amplitude Gain Control is active.

Value	Recommended Max Frequency [MHz]
0x0	2
0x1	4
0x2	8
0x3	16
0x4	30
0x5-0x7	Reserved

Bit 7 – ONDEMAND On Demand Control

The On Demand operation mode allows the oscillator to be enabled or disabled, depending on peripheral clock requests.

If the ONDEMAND bit has been previously written to '1', the oscillator will be running only when requested by a peripheral. If there is no peripheral requesting the oscillator's clock source, the oscillator will be in a disabled state.

If On Demand is disabled, the oscillator will always be running when enabled.

In standby sleep mode, the On Demand operation is still active.

Value	Description
0	The oscillator is always on, if enabled.
1	The oscillator is enabled when a peripheral is requesting the oscillator to be used as a clock source. The oscillator is disabled if no peripheral is requesting the clock source.

The Write-Synchronization of the Enable bit is triggered by writing a '1' to the Enable bit of the BOD33 Control register. The Synchronization Ready bit (STATUS.B33SRDY) in the STATUS register will be cleared when the Write-Synchronization starts, and set again when the Write-Synchronization is complete. Writing to the same register while the Write-Synchronization is ongoing (STATUS.B33SRDY is '0') will generate a PAC error without stalling the APB bus.

25.6.7 Low Power VREF in Active Mode

During active functional mode, the brownout detector BOD33 and the main voltage regulator (VREG) can reduce their power consumption by using the low power voltage reference (ULPVREF).

The low power voltage reference is ready and can be selected when ULPVREFRDY bit in [STATUS](#) register is high. The ULPVREF Ready (ULPVREFRDY) interrupt can also be used to detect a zero-to-one transition of the STATUS.ULPVREFRDY bit.

Writing the VREF bit in the BOD33 register to '1' selects ULPVREF as voltage reference for the BOD33.

If the chip operated in PL0 ((PM->PLCFG.PLSEL=0) or Performance Level is disabled (PM->PLCFG.PLDIS=1), writing the VREFSEL bit in the VREG register to '1' selects ULPVREF as voltage reference for the main voltage regulator.

26.6.6 Sleep Mode Operation

The Run-In-Standby bit in Control A (CTRLA.RUNSTDBY) control the behavior of the WDT during standby sleep mode. When the bit is zero, the watchdog is disabled during sleep, but maintains its current configuration. When CTRLA.RUNSTDBY is '1', the WDT continues to operate during sleep.

Related Links

[26.8.1 CTRLA](#)

26.6.7 Synchronization

Due to asynchronicity between the main clock domain and the peripheral clock domains, some registers need to be synchronized when written or read.

The following registers are synchronized when written:

- Enable bit in Control A register (CTRLA.ENABLE)
- Window Enable bit in Control A register (CTRLA.WEN)
- Run-In-Standby bit in Control A register (CTRLA.RUNSTDBY)
- Always-On bit in control Control A (CTRLA.ALWAYSON)
- Watchdog Clear register (CLEAR)

Required write-synchronization is denoted by the "Write-Synchronized" property in the register description.

Required read-synchronization is denoted by the "Read-Synchronized" property in the register description.

26.6.8 Additional Features

26.6.8.1 Always-On Mode

The Always-On mode is enabled by setting the Always-On bit in the Control A register (CTRLA.ALWAYSON=1). When the Always-On mode is enabled, the WDT runs continuously, regardless of the state of CTRLA.ENABLE. Once written, the Always-On bit can only be cleared by a power-on reset. The Configuration (CONFIG) and Early Warning Control (EWCTRL) registers are read-only registers while the CTRLA.ALWAYSON bit is set. Thus, the time period configuration bits (CONFIG.PER, CONFIG.WINDOW, EWCTRL.EWOFFSET) of the WDT cannot be changed.

Enabling or disabling Window mode operation by writing the Window Enable bit (CTRLA.WEN) is allowed while in Always-On mode, but note that CONFIG.PER cannot be changed.

The Interrupt Clear and Interrupt Set registers are accessible in the Always-On mode. The Early Warning interrupt can still be enabled or disabled while in the Always-On mode, but note that EWCTRL.EWOFFSET cannot be changed.

Table WDT Operating Modes With Always-On shows the operation of the WDT for CTRLA.ALWAYSON=1.

Table 26-2. WDT Operating Modes With Always-On

WEN	Interrupt Enable	Mode
0	0	Always-on and normal mode
0	1	Always-on and normal mode with Early Warning interrupt

28.8.6 Debug Control

Name: DBGCTRL
Offset: 0x0D
Reset: 0x00
Property: PAC Write-Protection

Bit	7	6	5	4	3	2	1	0
								DBGRUN
Access								R/W
Reset								0

Bit 0 – DBGRUN Debug Run

This bit is not reset by a software reset.

This bit controls the functionality when the CPU is halted by an external debugger.

Value	Description
0	The DMAC is halted when the CPU is halted by an external debugger.
1	The DMAC continues normal operation when the CPU is halted by an external debugger.

(ASYNCH.ASYNCH[x]). The EIC edge detection is operated synchronously when the Asynchronous Control Mode bit (ASYNCH.ASYNCH[x]) is '0' (default value). It is operated asynchronously when ASYNCH.ASYNCH[x] is written to '1'.

In *Synchronous Edge Detection Mode*, the external interrupt (EXTINT) or the non-maskable interrupt (NMI) pins are sampled using the EIC clock as defined by the Clock Selection bit in the Control A register (CTRLA.CKSEL). The External Interrupt flag (INTFLAG.EXTINT[x]) or Non-Maskable Interrupt flag (NMIFLAG.NMI) is set when the last sampled state of the pin differs from the previously sampled state. In this mode, the EIC clock is required.

The Synchronous Edge Detection Mode can be used in Idle and Standby sleep modes.

In *Asynchronous Edge Detection Mode*, the external interrupt (EXTINT) pins or the non-maskable interrupt (NMI) pins set the External Interrupt flag or Non-Maskable Interrupt flag (INTFLAG.EXTINT[x] or NMIFLAG.NMI) directly. In this mode, the EIC clock is not requested.

The asynchronous edge detection mode can be used in Idle and Standby sleep modes.

29.6.4.3 Interrupt Pin Debouncing

The external interrupt pin (EXTINT) edge detection can use a debouncer to improve input noise immunity. When selected, the debouncer can work in the synchronous mode or the asynchronous mode, depending on the configuration of the ASYNCH.ASYNCH[x] bit for the pin. The debouncer uses the EIC clock as defined by the bit CTRLA.CKSEL to clock the debouncing circuitry. The debouncing time frame is set with the debouncer prescaler DPRESALER.DPRESALERn, which provides the *low frequency clock* tick that is used to reject higher frequency signals.

The debouncing mode for pin EXTINT x can be selected only if the Sense bits in the Configuration y register (CONFIGy.SENSEx) are set to RISE, FALL or BOTH. If the debouncing mode for pin EXTINT x is selected, the filter mode for that pin (CONFIGy.FILTENx) can not be selected.

The debouncer manages an internal “valid pin state” that depends on the external interrupt (EXTINT) pin transitions, the debouncing mode and the debouncer prescaler frequency. The valid pin state reflects the pin value after debouncing. The external interrupt pin (EXTINT) is sampled continuously on EIC clock. The sampled value is evaluated on each *low frequency clock* tick to detect a transitional edge when the sampled value is different of the current valid pin state. The sampled value is evaluated on each EIC clock when DPRESALER.TICKON=0 or on each *low frequency clock* tick when DPRESALER.TICKON=1, to detect a bounce when the sampled value is equal to the current valid pin state. Transitional edge detection increments the transition counter of the EXTINT pin, while bounce detection resets the transition counter. The transition counter must exceed the transition count threshold as defined by the DPRESALER.STATESn bitfield. In the synchronous mode the threshold is 4 when DPRESALER.STATESn=0 or 8 when DPRESALER.STATESn=1. In the asynchronous mode the threshold is 4.

The valid pin state for the pins can be accessed by reading the register PINSTATE for both synchronous or asynchronous debouncing mode.

Synchronous edge detection In this mode the external interrupt (EXTINT) pin is sampled continuously on EIC clock.

1. A pin edge transition will be validated when the sampled value is consistently different of the current valid pin state for 4 (or 8 depending on bit DPRESALER.STATESn) consecutive ticks of the low frequency clock.
2. Any pin sample, at the *low frequency clock* tick rate, with a value opposite to the current valid pin state will increment the transition counter.

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NVMCTRL – Nonvolatile Memory Controller

Offset	Name	Bit Pos.								
		15:8	SLKEY[7:0]							
0x22	NSULCK	7:0						DNS	ANS	BNS
		15:8	NSLKEY[7:0]							
0x24	PARAM	7:0	FLASHP[7:0]							
		15:8	FLASHP[15:8]							
		23:16	DFLASHP[3:0]					PSZ[2:0]		
		31:24	DFLASHP[11:4]							
0x28 ... 0x2F	Reserved									
0x30	DSCC	7:0	DSCKEY[7:0]							
		15:8	DSCKEY[15:8]							
		23:16	DSCKEY[23:16]							
		31:24			DSCKEY[29:24]					
0x34	SECCTRL	7:0		DXN			DSCEN	SILACC		TAMPEEN
		15:8						TEROW[2:0]		
		23:16								
		31:24	KEY[7:0]							
0x38	SCFGB	7:0							BCWEN	BCREN
		15:8								
		23:16								
		31:24								
0x3C	SCFGAD	7:0								URWEN
		15:8								
		23:16								
		31:24								
0x40	NONSEC	7:0								WRITE
		15:8								
		23:16								
		31:24								
0x44	NSCHK	7:0								WRITE
		15:8								
		23:16								
		31:24								

30.8 Register Description

Registers can be 8, 16, or 32 bits wide. Atomic 8-, 16-, and 32-bit accesses are supported. In addition, the 8-bit quarters and 16-bit halves of a 32-bit register, and the 8-bit halves of a 16-bit register can be accessed directly.

Some registers require synchronization when read and/or written. Synchronization is denoted by the "Read-Synchronized" and/or "Write-Synchronized" property in each individual register description.

Some registers are enable-protected, meaning they can only be written when the module is disabled. Enable-protection is denoted by the "Enable-Protected" property in each individual register description.

Bit 11 – FWUP Cache Disable

This bit is used to disable the cache.

Value	Description
0	Fast wake-up is turned off
1	Fast wake-up is turned on

Bits 9:8 – SLEEPFRM[1:0] Power Reduction Mode during Sleep

Indicates the Power Reduction Mode during sleep.

Value	Name	Description
0x0	WAKEUPACCESS	NVM block enters low-power mode when entering sleep. NVM block exits low-power mode upon first access.
0x1	WAKEUPINSTANT	NVM block enters low-power mode when entering sleep. NVM block exits low-power mode when exiting sleep.
0x2	Reserved	
0x3	DISABLED	Auto power reduction disabled.

Bits 4:1 – RWS[3:0] NVM Read Wait States

These bits control the number of wait states for a read operation. '0' indicates zero wait states, '1' indicates one wait state, etc., up to 15 wait states.

This register is initialized to 0 wait states. Software can change this value based on the NVM access time and system frequency.

Writing a '1' to a bit will clear the corresponding bit in the DIR register, which configures the I/O pin as an input.

Value	Description
0	The corresponding I/O pin in the PORT group will keep its configuration.
1	The corresponding I/O pin in the PORT group is configured as input.

[35.8.13 DBGCTRL](#)

35.5.8 Register Access Protection

Registers with write-access can be write-protected optionally by the peripheral access controller (PAC).

PAC Write-Protection is not available for the following registers:

- Interrupt Flag Clear and Status register (INTFLAG)
- Status register (STATUS)
- Data register (DATA)

Optional PAC Write-Protection is denoted by the "PAC Write-Protection" property in each individual register description.

Write-protection does not apply to accesses through an external debugger.

Related Links

[15. PAC - Peripheral Access Controller](#)

35.5.9 SAM L11 TrustZone Specific Register Access Protection

On **SAM L11** devices, this peripheral has different access permissions depending on PAC Security Attribution (Secure or Non-Secure):

- If the peripheral is configured as Non-Secure in the PAC:
 - Secure access and Non-Secure access are granted
- If the peripheral is configured as Secure in the PAC:
 - Secure access is granted
 - Non-Secure access is discarded (Write is ignored, read 0x0) and a PAC error is triggered

Refer to *Peripherals Security Attribution* for more information.

35.5.10 Analog Connections

Not applicable.

35.6 Functional Description

35.6.1 Principle of Operation

The USART uses the following lines for data transfer:

- RXD for receiving
- TXD for transmitting
- XCK for the transmission clock in synchronous operation

USART data transfer is frame based. A serial frame consists of:

- 1 start bit
- From 5 to 9 data bits (MSB or LSB first)
- No, even or odd parity bit
- 1 or 2 stop bits

A frame starts with the start bit followed by one character of data bits. If enabled, the parity bit is inserted after the data bits and before the first stop bit. After the stop bit(s) of a frame, either the next frame can

SAM L10/L11 Family

SERCOM USART - SERCOM Synchronous and Asyn...

35.8.2 Control B

Name: CTRLB
Offset: 0x04
Reset: 0x00000000
Property: PAC Write-Protection, Enable-Protected, Write-Synchronized

Bit	31	30	29	28	27	26	25	24
Access								
Reset								

Bit	23	22	21	20	19	18	17	16
							RXEN	TXEN
Access							R/W	R/W
Reset							0	0

Bit	15	14	13	12	11	10	9	8
			PMODE			ENC	SFDE	COLDEN
Access			R/W			R/W	R/W	R/W
Reset			0			0	0	0

Bit	7	6	5	4	3	2	1	0
		SBMODE					CHSIZE[2:0]	
Access		R/W				R/W	R/W	R/W
Reset		0				0	0	0

Bit 17 – RXEN Receiver Enable

Writing '0' to this bit will disable the USART receiver. Disabling the receiver will flush the receive buffer and clear the FERR, PERR and BUFOVF bits in the STATUS register.

Writing '1' to CTRLB.RXEN when the USART is disabled will set CTRLB.RXEN immediately. When the USART is enabled, CTRLB.RXEN will be cleared, and SYNCBUSY.CTRLB will be set and remain set until the receiver is enabled. When the receiver is enabled, CTRLB.RXEN will read back as '1'.

Writing '1' to CTRLB.RXEN when the USART is enabled will set SYNCBUSY.CTRLB, which will remain set until the receiver is enabled, and CTRLB.RXEN will read back as '1'.

This bit is not enable-protected.

Value	Description
0	The receiver is disabled or being enabled.
1	The receiver is enabled or will be enabled when the USART is enabled.

Bit 16 – TXEN Transmitter Enable

Writing '0' to this bit will disable the USART transmitter. Disabling the transmitter will not become effective until ongoing and pending transmissions are completed.

Writing '1' to CTRLB.TXEN when the USART is disabled will set CTRLB.TXEN immediately. When the USART is enabled, CTRLB.TXEN will be cleared, and SYNCBUSY.CTRLB will be set and remain set until the transmitter is enabled. When the transmitter is enabled, CTRLB.TXEN will read back as '1'.

40.7 Register Summary

Offset	Name	Bit Pos.								
0x00	CTRL	7:0		RUNSTDBY				ENABLE	SWRST	
0x01	Reserved									
...										
0x03										
0x04	SEQCTRL0	7:0				SEQSEL[3:0]				
0x05	Reserved									
...										
0x07										
0x08	LUTCTRL0	7:0	EDGESEL		FILTSEL[1:0]				ENABLE	
		15:8	INSELx[3:0]				INSELx[3:0]			
		23:16		LUTEO	LUTEI	INVEI	INSELx[3:0]			
		31:24	TRUTH[7:0]							
0x0C	LUTCTRL1	7:0	EDGESEL		FILTSEL[1:0]				ENABLE	
		15:8	INSELx[3:0]				INSELx[3:0]			
		23:16		LUTEO	LUTEI	INVEI	INSELx[3:0]			
		31:24	TRUTH[7:0]							

40.8 Register Description

Registers can be 8, 16, or 32 bits wide. Atomic 8-, 16- and 32-bit accesses are supported. In addition, the 8-bit quarters and 16-bit halves of a 32-bit register, and the 8-bit halves of a 16-bit register can be accessed directly.

Some registers are optionally write-protected by the Peripheral Access Controller (PAC). Optional PAC write-protection is denoted by the "PAC Write-Protection" property in each individual register description. For details, refer to [40.5.8 Register Access Protection](#).

Some registers are enable-protected, meaning they can only be written when the peripheral is disabled. Enable-protection is denoted by the "Enable-Protected" property in each individual register description.

On **SAM L11** devices, this peripheral has different access permissions depending on PAC Security Attribution (Secure or Non-Secure):

- If the peripheral is configured as Non-Secure in the PAC:
 - Secure access and Non-Secure access are granted
- If the peripheral is configured as Secure in the PAC:
 - Secure access is granted
 - Non-Secure access is discarded (Write is ignored, read 0x0) and a PAC error is triggered

Refer to *Peripherals Security Attribution* for more information.

- Gain Correction (GAINCORR)
- Offset Correction (OFFSETCORR)

When one of these registers is written, the data is stored in the corresponding buffer as long as the current conversion is not impacted, and the corresponding busy status will be set in the Synchronization Busy register (SYNCBUSY). When a new RESULT is available, data stored in the buffer registers will be transferred to the ADC and a new conversion can start.

41.6.3.2 Device Temperature Measurement

Principle

The device has an integrated temperature sensor which is part of the Supply Controller (SUPC). The analog signal of that sensor can be converted into a digital value by the ADC. The digital value can be converted into a temperature in °C by following the steps in this section.

Configuration and Conditions

In order to conduct temperature measurements, configure the device according to these steps.

1. Configure the clocks and device frequencies according to the Electrical Characteristics chapters.
2. Configure the Voltage References System of the Supply Controller (SUPC):
 - 2.1. Enable the temperature sensor by writing a '1' to the Temperature Sensor Enable bit in the VREF Control register (SUPC.VREF.TSEN).
 - 2.2. Select the required voltage for the internal voltage reference INTREF by writing to the Voltage Reference Selection bits (SUPC.VREF.SEL). The required value can be found in the Electrical Characteristics chapters.
 - 2.3. Enable routing INTREF to the ADC by writing a '1' to the Voltage Reference Output Enable bit (SUPC.VREF.VREFOE).
3. Configure the ADC:
 - 3.1. Select the internal voltage reference INTREF as ADC reference voltage by writing to the Reference Control register (ADC.REFCTRL.REFSEL).
 - 3.2. Select the temperature sensor vs. internal GND as input by writing TEMP and GND to the positive and negative MUX Input Selection bit fields (ADC.INPUTCTRL.MUXNEG and .MUXPOS, respectively).
 - 3.3. Configure the remaining ADC parameters according to the Electrical Characteristics chapters.
 - 3.4. Enable the ADC and acquire a value, ADC_m .

Calculation Parameter Values

The temperature sensor behavior is linear, but it is sensitive to several parameters such as the internal voltage reference - which itself depends on the temperature. To take this into account, each device contains a Temperature Log row with individual calibration data measured and written during the production tests. These calibration values are read by software to infer the most accurate temperature readings possible.

The Temperature Log Row basically contains the following parameter set for two different temperatures ("ROOM" and "HOT"):

- Calibration temperatures in °C. One at room temperature $temp_R$, one at a higher temperature $temp_H$:
 - ROOM_TEMP_VAL_INT and ROOM_TEMP_VAL_DEC contain the measured temperature at room insertion, $temp_R$, in °C, separated in integer and decimal value.

Equation 3 is a coarse value, because we assumed that $INT1V_c = 1V$. To achieve a more accurate result, we replace $INT1V_c$ with an interpolated value $INT1V_m$. We use the two data pairs ($temp_R$, $INT1V_R$) and ($temp_H$, $INT1V_H$) and yield:

$$\left(\frac{INT1V_m - INT1V_R}{temp_m - temp_R} \right) = \left(\frac{INT1V_H - INT1V_R}{temp_H - temp_R} \right)$$

Using the coarse temperature value $temp_c$, we can infer a more precise $INT1V_m$ value during the ADC conversion as:

[Equation 4]

$$INT1V_m = INT1V_R + \left(\frac{(INT1V_H - INT1V_R) \cdot (temp_c - temp_R)}{(temp_H - temp_R)} \right)$$

Back to Equation 3, we replace the simple $INT1V_c = 1V$ by the more precise $INT1V_m$ of Equation 4, and find a more accurate temperature value $temp_f$:

[Equation 5]

$$temp_f = temp_R + \left[\frac{\{ADC_m \cdot INT1V_m - (ADC_R \cdot INT1V_R)\} \cdot (temp_H - temp_R)}{\{(ADC_H \cdot INT1V_H) - (ADC_R \cdot INT1V_R)\}} \right]$$

41.6.4 DMA Operation

The ADC generates the following DMA request:

- Result Conversion Ready (RESRDY): the request is set when a conversion result is available and cleared when the RESULT register is read. When the averaging operation is enabled, the DMA request is set when the averaging is completed and result is available.

41.6.5 Interrupts

The ADC has the following interrupt sources:

- Result Conversion Ready: RESRDY
- Window Monitor: WINMON
- Overrun: OVERRUN

These interrupts, except the OVERRUN interrupt, are asynchronous wake-up sources. See *Sleep Mode Controller* for details.

Each interrupt source has an interrupt flag associated with it. The interrupt flag in the Interrupt Flag Status and Clear (INTFLAG) register is set when the interrupt condition occurs. Each interrupt can be individually enabled by writing a one to the corresponding bit in the Interrupt Enable Set (INTENSET) register, and disabled by writing a one to the corresponding bit in the Interrupt Enable Clear (INTENCLR) register. An interrupt request is generated when the interrupt flag is set and the corresponding interrupt is enabled. The interrupt request remains active until the interrupt flag is cleared, the interrupt is disabled, or the ADC is reset. See INTFLAG register for details on how to clear interrupt flags. All interrupt requests from the peripheral are ORed together on system level to generate one combined interrupt request to the NVIC. Refer to *Nested Vector Interrupt Controller* for details. The user must read the INTFLAG register to determine which interrupt condition is present.

Note that interrupts must be globally enabled for interrupt requests to be generated. Refer to *Nested Vector Interrupt Controller* for details.

Related Links

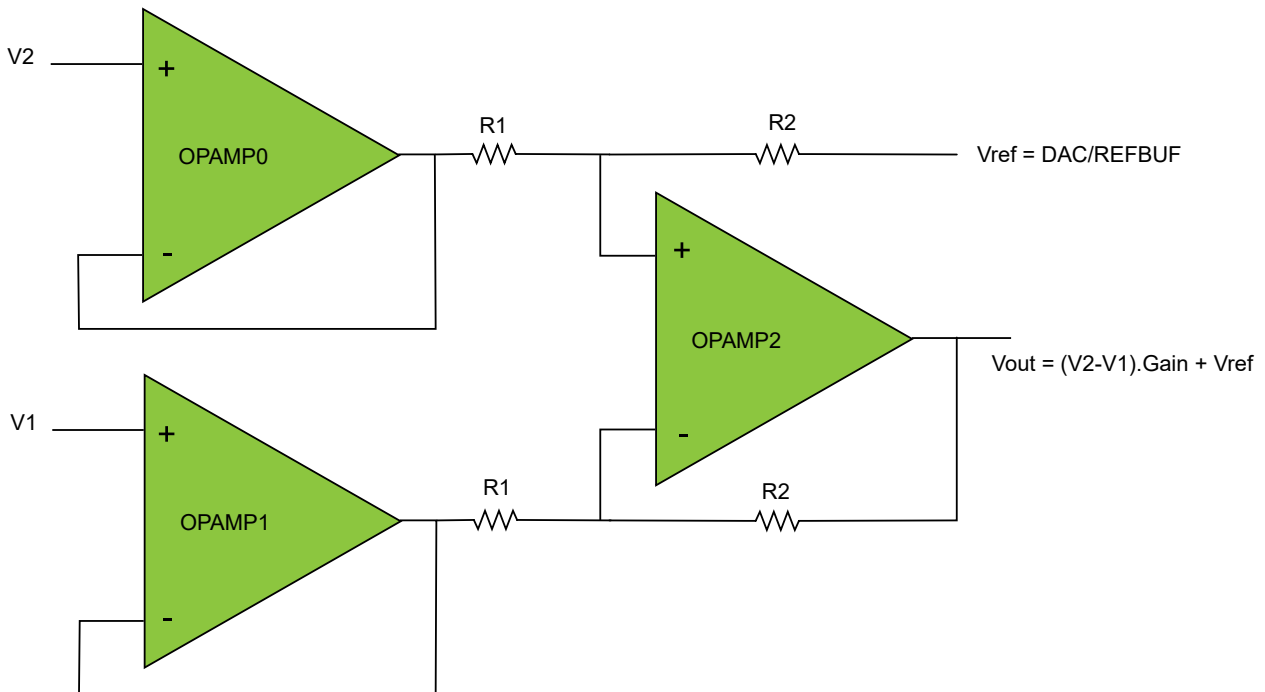
[22.6.3.3 Sleep Mode Controller](#)

Table 44-10. Instrumentation Amplifier Gain Selection

OPAMPCTRL0.POTMUX	OPAMPCTRL2.POTMUX	GAIN
0x7	Reserved	Reserved
0x6	0x0	1/7
0x5	Reserved	Reserved
0x4	0x1	1/3
0x3	Reserved	Reserved
0x2	0x2	1
0x1	0x4	3
0x0	0x6	7

Note: Either the DAC or GND must be the reference, selected by the OPAMPCTRL0.RES1MUX bits. Refer to the OPAMP Control 'x' register ([44.8.3 OPAMPCTRL](#)) for details.

Figure 44-8. Instrumentation amplifier



44.6.10.8 High Gain Instrumentation Amplifier

In this mode, OPAMP0 and OPAMP1 are configured as non inverting amplifiers [Stage 1]. OPAMP2 is configured as difference amplifier[Stage 2]. Total gain of the instrumentation amplifier is product of gains of stage 1 and stage 2. The OPAMPCTRLx and RESCTRL registers can be configured as follows:

SAM L10/L11 Family

125°C Electrical Characteristics

Mode	Conditions	Regulator Mode	Vcc	Ta	Typ.	Max.	Units
	4kB RAM retained,PDSW domain in retention	LPEFF Disable	1,8V	125°C	15.5	33.2	μA
				25°C	0.5	0.9	
		LPEFF Enable	3,3V	125°C	22.0	58.9	
				25°C	0.5	0.9	
		BUCK in standby PL0 (VREG.RUNSTDBY=1 and VREG.STDBYPL0=1)	1,8V	25°C	0.7	1.0	
				125°C	18.4	42.7	
			3,3V	25°C	0.8	1.5	
				125°C	14.6	31.0	
	4kB RAM retained,PDSW domain in retention and RTC running on XOSC32k	LPEFF Disable	1,8V	25°C	0.9	1.3	
				125°C	22.6	59.8	
		LPEFF Enable	3,3V	25°C	0.8	1.2	
				125°C	19.3	42.1	
		BUCK in standby PL0 (VREG.RUNSTDBY=1 and VREG.STDBYPL0=1)	1,8V	25°C	1.0	1.3	
				125°C	19.0	43.3	
			3,3V	25°C	1.1	1.7	
				125°C	15.2	31.6	
OFF			1,8V	25°C	34.6	54.4	nA
				125°C	4385.0	8291.5	
			3,3V	25°C	61.2	89.1	
				125°C	5489.5	10564.7	

47.4 Analog Characteristics

47.4.1 Brown-Out Detectors (BOD) Characteristics

Table 47-4. BOD33 Characteristics with BOD33.VREFSEL = 0

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Unit
VBOD+ ⁽²⁾	BOD33 high threshold level	BOD33.LEVEL = 6	1.66	1.68	1.70	V
		BOD33.LEVEL = 7	1.70	1.72	1.74	
		BOD33.LEVEL = 39	2.79	2.84	2.89	